

Dependence of NO₂ gas sensitivity of WO₃ sputtered films on film density

Cheng-Ji Jin^a, Toshinari Yamazaki^{a,*}, Yashuyoshi Shirai^a, Toshio Yoshizawa^a,
Toshio Kikuta^a, Noriyuki Nakatani^a, Humio Takeda^b

^aFaculty of Engineering, Toyama University, 3190 Gofuku, Toyama, 930-8555, Japan

^bToyama National College of Technology, 13 Hongo-machi, Toyama, 939-8630, Japan

Received 29 January 2004; received in revised form 19 July 2004; accepted 2 September 2004

Available online 27 October 2004

Abstract

Pure WO₃ films and WO₃ films doped with noble metals such as Au, Pt, and Ru were deposited on quartz substrates by dc reactive magnetron sputtering to investigate the NO₂ gas sensitivity. The temperature of the substrate and the pressure of the discharge gas were changed. The film structures were studied by X-ray diffraction, atomic force microscopy, and density measurements. The WO₃ films had a triclinic structure and seemed to be composed of columns surrounded by voids. The film density decreased as the discharge gas pressure increased and the substrate temperature decreased. Gas sensitivity was measured at an NO₂ gas concentration of 3 ppm. Low film density and Au doping caused a high sensitivity to NO₂ gas. The highest sensitivity was observed in a film with an Au concentration of 0.25 at.% and a density of 5.0 g/cm³, which was significantly smaller than the bulk density of 7.3 g/cm³.

© 2004 Elsevier B.V. All rights reserved.

PACS: 81.15.C; 07.07.D

Keywords: Tungsten oxide; Sputtering; Nitrogen dioxide; Sensors

1. Introduction

In recent years, exhaust gas generation from automobiles and factories, etc., has created a serious air pollution problem all over the world. In particular, nitrogen oxide NO_x (NO₂ or NO) is toxic in itself and, furthermore, is a main source of acid rain and photochemical smog [1]. In environmental monitoring, the threshold limit values for NO₂ and NO have been determined to be 3 and 25 ppm, respectively, as listed in the safety standards by the American Conference of Governmental Industrial Hygienists. Because NO gas tends to be oxidized into NO₂ gas in air [2], the development of a small NO₂ gas sensor with high sensitivity to low concentrations of NO₂ gas is strongly required.

Numerous attempts to use various metal oxide semiconductors as gas sensors have been made. Among those semiconductors, WO₃, an n-type semiconductor whose free electrons originate primarily from oxygen vacancies [3], shows excellent sensing properties with low concentrations of NO₂ gas. Therefore, WO₃ thin film is considered to be a promising NO₂ gas sensor [4–7]. Various attempts have been made to enhance the gas sensitivity of semiconductor gas sensors, one of which involved the doping of impurities in films. Penza et al. [8,9] have shown that a high sensitivity is achieved when noble metals such as Pt, Au, and Pd, etc. are deposited as activator layers on WO₃ films because of the effects of agglomeration of the noble metals on the surface of the WO₃ films. Zhao et al. [10] have reported that Al and Ti doping change the crystal structures of tungsten oxide films deposited by pulsed laser deposition from triclinic WO₃ to tetragonal WO_{2.90}. They have also mentioned that Al and Ti doping greatly improve the NO₂

* Corresponding author. Tel.: +81 76 445 6882; fax: +81 76 445 6882.

E-mail address: yamazaki@eng.toyama-u.ac.jp (T. Yamazaki).

gas sensitivity due to the formation of fine crystallites in a tetragonal $\text{WO}_{2.90}$ film. Akiyama et al. [11] have reported that the NO gas sensitivity is improved by doping Pt, Au, and Ru to a WO_3 sintered sensor element, since the adsorption of the gas related to NO is increased. With regard to an Ag-doped WO_3 sintered sensor, Chen et al. [12] have found that Ag doping creates high concentrations of oxygen vacancies functioning as adsorption sites and improves the sensitivity to NO gas. Another attempt at improving gas sensitivity involved creating a porous film, as a porous film provides more surface adsorption sites for the detection gas. According to the microstructure model of sputtered films presented by Thornton [13], the sputtered films deposited under conditions of low temperature and high discharge gas pressure usually have a columnar structure and the columns are surrounded by voids. As the substrate temperature decreases and the discharge gas pressure increases, voids develop and the density of the film decreases. As such, Kunimoto et al. [14] and Yamazaki et al. [15] have investigated the influence of deposition conditions of SnO_2 sputtered films on the film structure and have discussed the relation between the film structure and H_2 gas sensitivity. They found that a porous film has a high sensitivity. In the present study, we investigated the effects of doping of noble metals (Pt, Au, and Ru) and the porosity of WO_3 films on NO_2 gas sensitivity.

2. Experimental details

WO_3 films were deposited on $15 \times 15 \text{ mm}^2$ quartz substrates by reactive dc magnetron sputtering. A circular tungsten target 100 mm in diameter with a purity of 99.99% supplied by Furuuchi Chemical was used. For Au, Pt, and Ru doping, pieces of these metals 0.1 mm in thickness were

placed on the tungsten target. The discharge gas was an argon–oxygen mixture with a ratio of $\text{Ar}/\text{O}_2=1:1$. Before deposition, the target was presputtered for 300 s with a shutter closed. The discharge gas pressure was changed between 1.3 and 10 Pa. The discharge current was fixed at 50 mA, and the discharge voltage took a value between 580 V and 480 V depending on the gas pressure. The substrate temperature was changed between room temperature and 673 K. The film thickness was approximately 100 nm. After deposition, the films supplied for the measurement of the sensing properties were annealed at 873 K for 14.4 ks in air to stabilize the sensing properties. Pt interdigital electrodes were then formed on the films.

The crystallographic structure and the surface morphology of sputtered WO_3 films were studied by means of X-ray diffraction (XRD) with $\text{Cu-K}\alpha$ radiation and atomic force microscopy (AFM) in contact mode with silicon nitride tip, respectively. A diffractometer (Rigaku Rint 1000) and an atomic force microscope (Digital Ins. NanoScope III) were used in these measurements. The concentrations of the noble metals doped in the films were measured by an electron probe X-ray microanalyzer (Shimadzu EPMA-1500). The film density was determined after annealing at 873 K by measuring the thickness and mass of the films using a mechanical surface roughness tester (Kosaka SE-30D) and an electronic balance (Mettler Toled MT5). The measurement error of the thickness and that of the mass were 3 nm and 1 μg , respectively; these values correspond to the uncertainty of 3% and 1%. Therefore, the uncertainty of the measured density is estimated to be about 4%.

To evaluate the sensitivities, sensor samples were installed in an aluminum vessel with a capacity of $13 \times 10^{-3} \text{ m}^3$ and were heated from the back of the quartz substrate using an electric heater. The heater was made of a nichrome wire wound around a mica plate and was

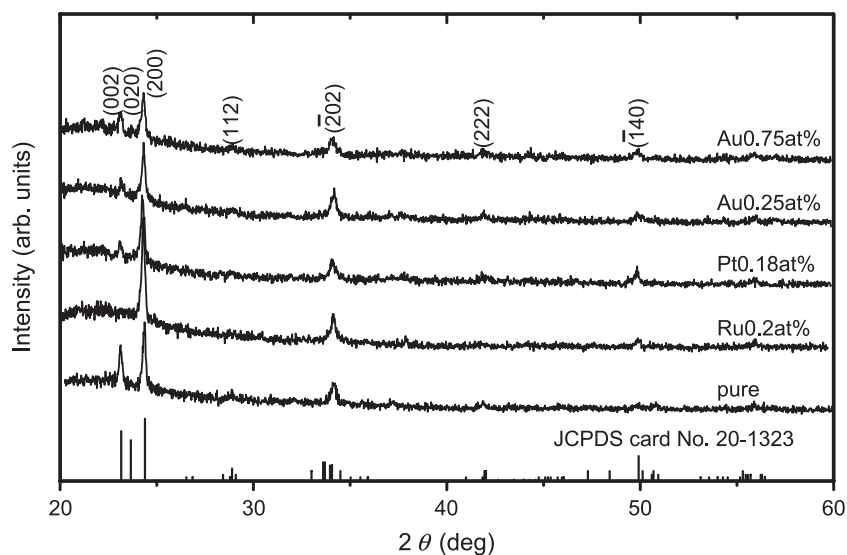


Fig. 1. XRD patterns of pure as well as Au, Pt, and Ru-doped WO_3 films after annealing at 873 K. The discharge gas pressure and the substrate temperature during the deposition were 1.3 Pa and room temperature, respectively.

Download English Version:

<https://daneshyari.com/en/article/9812986>

Download Persian Version:

<https://daneshyari.com/article/9812986>

[Daneshyari.com](https://daneshyari.com)